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Dimensions

Chip Size	1825
L	4.5mm +/-0.3mm (0.177 in +/-0.012 in)
W	6.4mm +/-0.3mm (0.252 in +/-0.012 in)
T	1.5mm (0.059 in)
B	0.5mm +/-0.3mm (0.02 in +/-0.012 in)

Packaging Specifications

Packaging	T&R, 178mm, Plastic Tape
Packaging Quantity	1100

General Information

Series	SMD Mil PRF55681
Style	SMD Chip
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov .
Termination	Lead (SnPb)
Failure Rate	M (1%/1000 Hrs)
Testing and Reliability	MIL-PRF-55681
Qualifications	MIL-PRF-55681
AEC-Q200	No
Miscellaneous	Termination Description: SolderPlate 70-30.
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	0.33 uF
Capacitance Tolerance	10%
Voltage DC	50 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BX

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